

### Description

The NTTFS4932N uses advanced trench technology

to provide excellent  $R_{\text{DS(ON)}},$  low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

### **General Features**

V<sub>DS</sub> = 30V I<sub>D</sub> =150A

 $R_{DS(ON)} < 2.4 m\Omega V_{GS} = 10V$ 

## Application

Battery protection

Load switch

Uninterruptible power supply

### Package Marking and Ordering Information

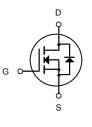
Pro	oduct ID	Pack	Brand	Qty(PCS)			
NT	TFS4932N	DFN5X6-8L	HXY MOSFET	5000			

#### Absolute Maximum Ratings (Tc=25 °C unless otherwise noted)

Symbol	Parameter	Rating	Units
Vds	VDs Drain-Source Voltage		V
Vgs	Gate-Source Voltage	±20	V
l₀@Tc=25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	150	А
I₀@Tc=100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	80	А
Ідм	Pulsed Drain Current <sup>2</sup>	160	А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	180	mJ
las	Avalanche Current	60	A
PD@Tc=25°C	Total Power Dissipation <sup>4</sup>	187	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Reja	Thermal Resistance Junction-Ambient <sup>1</sup>	62	°C/W
Rejc	Thermal Resistance Junction-Case <sup>1</sup>	1.1	°C/W







N-Channel MOSFET



## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
$\triangle BV_{\text{DSS}} / \triangle T_{\text{J}}$	BV <sub>DSS</sub> Temperature Coefficient Reference to 25°C , I <sub>D</sub> =1mA			0.014		V/°C
Basian	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =30A		2	2.4	mΩ
Rds(on)		V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		2.5	3.2	
$V_{GS(th)}$	Gate Threshold Voltage		1.2		2.5	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	VGS-VDS, ID -2300A		-4		mV/°C
l	Drain Source Lookage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C	1		1	
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	uA
lgss	Gate-Source Leakage Current V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V				±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =30A		50		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.7		Ω
Qg	Total Gate Charge (4.5V)	V <sub>DS</sub> =15V , V <sub>GS</sub> =10V , I <sub>D</sub> =15A		56.9		
Qgs	Gate-Source Charge			13.8		nC
$Q_{gd}$	Gate-Drain Charge			23.5		
T <sub>d(on)</sub>	Turn-On Delay Time			20.1		
Tr	Rise Time	$V_{DD}$ =15V , $V_{GS}$ =10V , $R_G$ =3.3 $\Omega$ , I <sub>D</sub> =1A		6.3		ns
T <sub>d(off)</sub>	Turn-Off Delay Time			124.6		
T <sub>f</sub>	Fall Time			15.8		
Ciss	Input Capacitance			4345		
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		340		pF
Crss	Reverse Transfer Capacitance			225		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,6</sup>	$V_G=V_D=0V$ , Force Current			150	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1.2	V

Note :

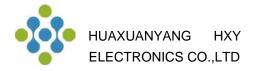
1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%

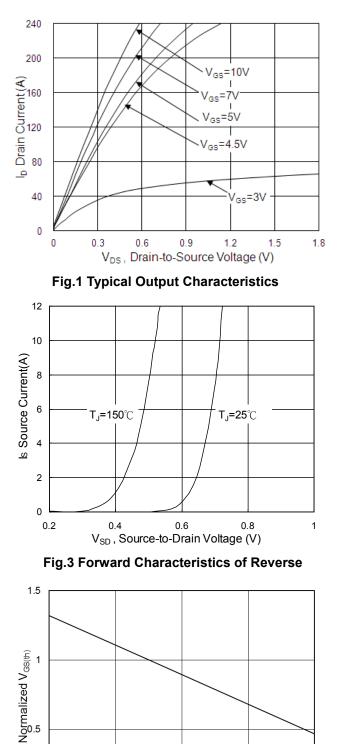
3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =60A

4. The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation. 6. Package limitation current is 85A.



## **Typical Characteristics**



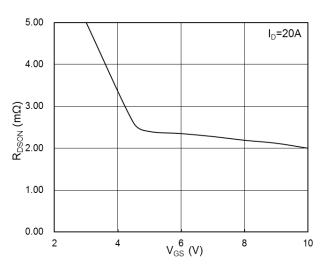


Fig.2 On-Resistance v.s Gate-Source

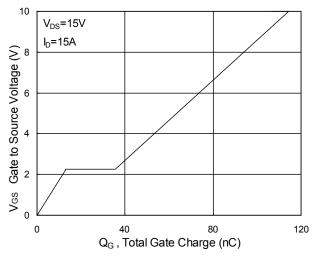


Fig.4 Gate-Charge Characteristics

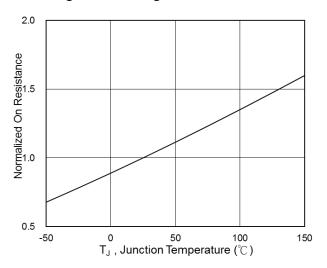
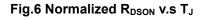


Fig.5 Normalized  $V_{GS(th)}$  v.s T<sub>J</sub>

150

0 50 100 T<sub>J</sub> ,Junction Temperature (  $^{\circ}\mathbb{C}$  )



0

-50



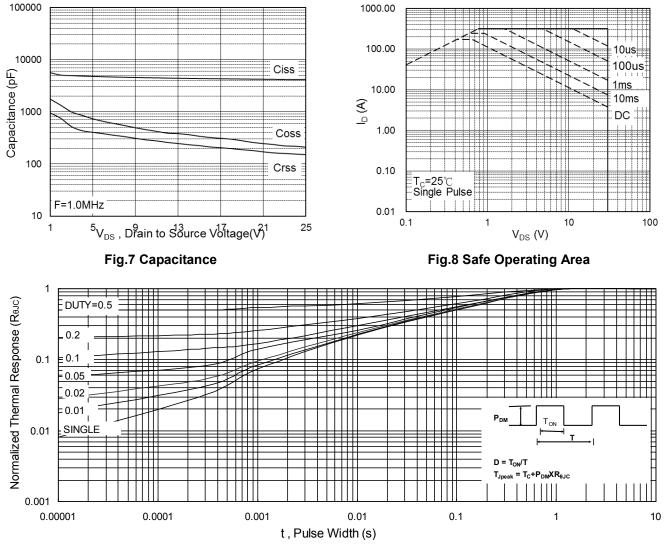
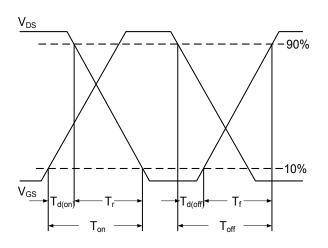
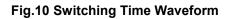


Fig.9 Normalized Maximum Transient Thermal Impedance





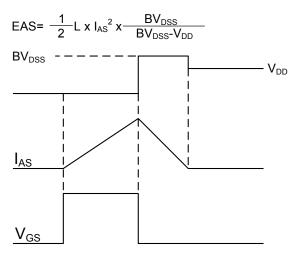
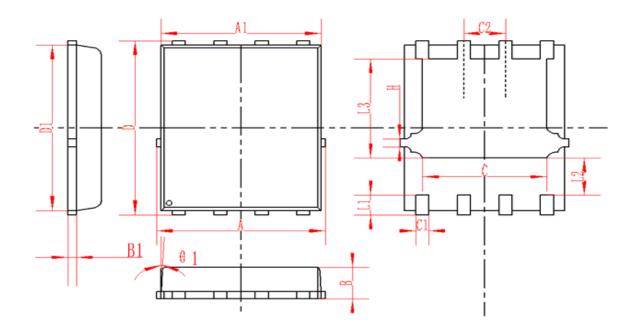


Fig.11 Unclamped Inductive Switching Waveform



# DFN5X6-8L Package Information



SYMBOL	MM			INCH			
STIVIDOL	MIN	NOM	MAX	MIN	NOM	MAX	
А	4.95	5	5.05	0.195	0.197	0.199	
A1	4.82	4.9	4.98	0.190	0.193	0.196	
D	5.98	6	6.02	0.235	0.236	0.237	
D1	5.67	5.75	5.83	0.223	0.226	0.230	
В	0.9	0.95	1	0.035	0.037	0.039	
B1	0.254REF			0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159	
C1	0.35	0.4	0.45	0.014	0.016	0.018	
C2		1.27TYP			0.5TYP		
θ1	8°	10°	12°	8°	10°	12°	
L1	0.63	0.64	0.65	0.025	0.025	0.026	
L2	1.2	1.3	1.4	0.047	0.051	0.055	
L3	3.415	3.42	3.425	0.134	0.135	0.135	
Н	0.24	0.25	0.26	0.009	0.010	0.010	



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